Analysis of Hydrogen Contamination of Superconducting Cavities

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Abstract

According to the thermodynamic behaviors hydrogen can be dissolved in the niobium even niobium hydride can be formed below 1000K. A model of hydrogen diffusion in niobium is proposed. The internal stress caused by dissolved hydrogen can establish the steady state of hydrogen distribution. The hydrogen contamination during chemical polishing is inverse proportional to the doping rate of the chemical polishing acid and its thickness is $\sim 10 - 30\mu$. During annealing at lower temperature an area of saturation solid solution can be formed and its boundary can become the nucleation sites, then the precipitation on the cavity surface can be reduced when the cavity is cooldown.

1 Introduction

Hydrogen atoms occupy interstitial sites in metals and diffuse much faster than any other atoms. Hydrogen absorbed in niobium during chemical polishing and precipitated as niobium hydrides on the surface of the superconducting cavity will reduce severely the Q value of the cavity[1].

In this paper the thermodynamic behaviors of hydrogen in niobium are discussed. A model of hydrogen diffusion in niobium is proposed to discuss the hydrogen contamination during chemical polishing and niobium hydride precipitation on the surface. By using this model the experiments on hydrogen contamination of superconducting cavities [1] can be explained. Therefore, investigation on hydrogen behaviors in superconducting cavities will be advantageous to further improve the performance of the cavity.

2 Thermodynamic behaviors

The chemical potential of hydrogen dissolved in niobium can be represented as[2]

$$\mu_H = \mu_H^{NbH} + RTln(\gamma_H C_H)$$
 (2.1)

where μ_H^{NbH} is the chemical potential of hydrogen in niobium hydride; C_H is the concentration and γ_H is the activity coefficient of hydrogen which represents the interaction between solute and matrix. $RTln\gamma_H$ can be regarded as the excess chemical potential

$$\Delta \mu_H \equiv RT \ln \gamma_H \equiv \Delta h_H - T \Delta s_H \tag{2.2}$$

where Δh_H and Δs_H are the excess enthalpy and entropy, respectively. If μ_H^{NbH} is assumed to be zero, then the excess chemical potential $\Delta \mu_H$ is equal to the hydrogen chemical potential in a unit concentration solid solution.

The chemical potential μ_H decreases with decreasing hydrogen concentration C_H . Niobium hydride will be precipitated when $\mu_N \geq \mu_H^{NbH}$, so the maximum solubility of hydrogen in niobium C_H^{max} can be written as

$$C_H^{max} = \frac{1}{\gamma_H} = exp(-\frac{\Delta\mu_H}{RT})$$
(2.3)

The chemical potential of hydrogen gas can be written as

$$\frac{1}{2}\mu_{H_2} = \mu_H^{NbH} + \frac{1}{2}RTlnP_{H_2} + \frac{1}{2}\Delta\mu_{H_2} \qquad (2.4)$$

According to Nb-H phase diagram [4], $\beta - NbH$ exists below 360K, so the niobium hydride will be precipitated when $\frac{1}{2}\mu_{H_2} \geq \mu_H^{NbH}$ and $T \leq 360K$. The maximum partial pressure of hydrogen can be written as

$$P_{H_2}^{max} = exp(-\frac{\Delta \mu_{H_2}}{RT}); \quad T < 360K$$
 (2.5)

The excess chemical potentials depend on the units of concentration and pressure of hydrogen. In this paper the units of concentration C_H and pressure P_{H_2} are $wppm(\mu gH/gNb)$ and mbar, respectively. The excess chemical potentials measured by experiments[2] are:

$$-\Delta \mu_H = 11240 - 89.05T(J/mol)$$
(2.6)

$$-\frac{1}{2}\Delta\mu_{H_2} = 49530 - 65.69T(J/mol)$$
(2.7)

Here $-\Delta \mu_H$ can be regarded as the chemical potential of NbH from dissolved hydrogen(1wppm) and niobium; $-\frac{1}{2}\Delta \mu_{H_2}$ the chemical potential of NbH from hydrogen gas(1 mbar) and niobium. The maximum solubilities and

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Table 1:	The	maximum	hvdrogen	solubilities an	d pressures
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T(K)	350	300	250	200	150
C_H^{max}	941	494	2 01	52	5.5
$P_{H_2}^{max}$	$1 \cdot 10^{-8}$	$4 \cdot 10^{-11}$	$1 \cdot 10^{-15}$		

Units: C_{H}^{max} (wppm); $P_{H_2}^{max}$ (mbar)

pressures of hydrogen are presented in Table 1. The partial hydrogen pressure in atmosphere is about 10^{-4} mbar and it can reach 10^{-10} mbar in an ultra-high-vacuum chamber in which H_2 is the mainly residual gas. When the vacuum pumps are shut off, H_2 pressure increase for a transient period to $10^{-8} - 10^{-7}$ mbar[3]. The niobium hydride will be stable thermodynamically below room temperature even in ultra-high-vacuum chamber. From experiments[1] the hydrogen contamination only concentrates on the niobium surface so that the dynamic behavior of hydrogen in niobium must be considered.

The hydrogen contamination in niobium can be removed by vacuum heat treating. From equations (2.1) and (2.4), i.e., $\Delta \mu_H = \frac{1}{2} \Delta \mu_{H_2}$, we can get

$$\frac{P_{H_2}}{C_H^2} = exp(-\frac{9211}{T} - 5.62)$$
(2.8)

To remove hydrogen in niobium the temperature should be higher than 1000K, e.g., $P_{H_2}/C_H^2 = 3.6 \cdot 10^{-7}$, T = 1000Kand $P_{H_2}/C_H^2 = 1.7 \cdot 10^{-6}$, T = 1200K, so the hydrogen concentration can be less than 1wppm under vacuum heat treatment.

In oder to study hydrogen contamination during chemical polishing and hydride precipitated successively on the niobium surface we must further investigate the diffusion behaviors of hydrogen in niobium.

3 Diffusion model

Dissolved hydrogen can cause the niobium lattice to expand[4]:

$$\Delta a/a = 4.72 \cdot 10^{-4} / \% H/Nb$$

Thus, the internal stress caused by the dissolved hydrogen can act as diffusion barriers, which can establish the steady state of hydrogen distribution. These induced excessive elastic stresses may lead to plastic deformation and cracks especially at dislocations and grain boundaries.

The driving force for diffusion is a chemical potential gradient. From (2.1)

$$\frac{\partial \mu_H}{\partial x} = \frac{RT}{C_H} \left(1 + \frac{C_H}{\gamma_H} \frac{\partial \gamma_H}{\partial C_H}\right) \frac{\partial C_H}{\partial x}$$
(3.1)

The current density j_H can be written as

$$j_H = -M_H \frac{\partial \mu_H}{\partial x} = -D_H^* \frac{\partial C_H}{\partial x}$$
(3.2)

with M_H the mobility and D_H^* the chemical diffusion coefficient. Substituting (3.2) into (3.1), we get

$$D_{H}^{*} = D_{H} \left(1 + \frac{C_{H}}{\gamma_{H}} \frac{\partial \gamma_{H}}{\partial C_{H}}\right)$$
(3.3)

where

$$D_H = \frac{RT}{C_H} M_H$$

is the trace diffusion coefficient $(C_H \sim 0)$, which can be measured by experiment.

The maximum solubility of hydrogen in niobium is very small below room temperature (Table 1), so we can expect that the interaction between hydrogens during saturation is very strong. From (2.3), $\gamma_H = (C_H^{max})^{-1}$, thus

$$\frac{\partial \gamma_H}{\partial C_H} = -(C_H^{max})^{-2}; \quad C_H \sim C_H^{max}$$
(3.4)

then the chemical diffusion coefficient

$$D_{H}^{*} = D_{H} \left(1 - \frac{C_{H}}{C_{H}^{max}}\right)$$
(3.5)

Hydride and solid solution can coexist during saturation $(C_H = C_H^{max})$. The hydrogen concentration on phase boundaries is discontinuous, so the chemical diffusion coefficient must be zero.

 C_H^{max} is very small when temperature is below room temperature, so we can expect that the interaction between hydrogen $(\partial \gamma_H / \partial C_H)$ may be constant when $C_H < C_H^{max}$.

If $C_H > C_H^{max}$, then $D_H^* < 0$. It means that the hydrogen will diffuse from low concentration to high concentration in the super-saturated solution. This chemical diffusion coefficient (3.5) can be used to describe the segregation process (pre-precipitation). The segregation process can be accelerated since not only the concentration gradient but also the chemical diffusion coefficient can increase with time.

The trace diffusion coefficient D_H and C_H^{max} decrease exponentially with temperature, thus D_H^* during supersaturation is nearly independent of temperature. Therefore, the segregation from super-saturated solution will develop very rapid even at very low temperature. This is agreement with the experiments[6].

According to Nb-H phase diagram [4], $\epsilon - Nb_4H_{3-x}$ will be precipitated from super-saturated solution when T < -70C. The hydrogen concentration in $\epsilon - Nb_4H_{3-x}$ is about 7795 wppm. When hydrogen concentration is near to this value, the chemical diffusion coefficient must reapproach to zero and the equation (3.5) is invalid.

The density of niobium is $8.55g/m^3$ and that of ϵ is $\sim 8.72g/m^3$, so the volume will be reduced during precipitation. This will cause to form dense dislocations with prismatic loop around hydride particles.

The internal stress may increase during segregation, but will be relaxed during precipitation, so the amount of niobium hydride precipitated on the niobium surface may mainly depend on the segregation process. The nucleation can be formed during segregation. Therefore, we can use the chemical diffusion coefficient (3.5) to discuss the hydrogen contamination during chemical polishing and hydrogen segregation.

4 Hydrogen contamination

Under the influence of internal stress caused by the dissolved hydrogen, the steady state can be established in which the hydrogen current density in niobium j_H is equal to the doping rate of the chemical polishing acid v_H :

$$j_H = -D_H (1 - \frac{C_H}{C_H^{max}}) \frac{\partial C_H}{\partial x} = v_H \qquad (4.1)$$

The boundary condition $C_H(x=0) = C_H^{max}$, then

$$C_H(\boldsymbol{x}) = C_H^{max} - \sqrt{\frac{C_H^{max} v_H \boldsymbol{x}}{D_H}}$$
(4.2)

and the maximum diffusion depth

$$x_{max} = \frac{C_H^{max} D_H}{v_H} \tag{4.3}$$

The amount of hydrogen content

$$AH = \int_0^{x_{max}} C_H(x) \, dx = \frac{1}{3} x_{max} C_H^{max} \qquad (4.4)$$

The chemical polishing is highly exothermic. The temperature gradient can affect the temperature distribution. From (2.1)

$$-\frac{\partial \mu_H}{\partial T} = \Delta s_H - R ln C_H \tag{4.5}$$

If $\partial \mu_H / \partial T = 0$,

$$C_{H}^{cr} = exp(\frac{\Delta s_{H}}{R}) \sim 4.5 \cdot 10^{4} wppm$$

Thus, when the hydrogen concentration is smaller than C_H^{er} , the hydrogen will move to high temperature under the temperature gradient. Therefore, under the effect of temperature gradient the hydrogen depth penetrated into niobium x_{max} can be further reduced.

If $x_{max} = 20\mu$, $D_H \sim 10^{-5} cm^2 s^{-1}$ and $C_H^{max} = 500$ wppm, then

$$w_H = rac{D_H \cdot C_H^{max}}{x_{max}} \sim 2.5 cm \cdot wppm \cdot s^{-1}$$

If the thickness of the sample is 2mm, then the average hydrogen content is \sim 3 wppm.

In chemical polishing the hydrogen contamination (4.4) is proportional to $(C_H^{max})^2$, D_H and inverse proportional to v_H . C_H^{max} , D_H and v_H usually increase with temperature and can be respectively represented as

$$C^0_H exp(-rac{E_C}{RT}), \ D^0_H exp(-rac{E_D}{RT}). \ D^0_\tau exp(-rac{E_\tau}{RT})$$

Their mainly changes may happen at different temperature ranges because of their different activation energies. The binding energy between oxygen and niobium is very large. The enthalpy of NbO from oxygen gas and niobium is ~ $-416070 J mol^{-1}$ [2], and the enthalpy of NbH is only ~ $-49530 J mol^{-1}$ (2.7), so the oxide layer will exist on the niobium surface below 1000K and its thickness is ~ 2 - 6nm[5]. This oxide layer can act as the barriers for hydrogen diffusion, but it can not completely prevent the hydrogen diffusion. The experiments[5] show that the oxide layer grows faster when OH^- ion exists in solution. We can expect that the OH^- ion will be beneficial to form (OH) in niobium, so it will accelerate the growth of oxide layer and cause the layer positive charging[5].

The etching process can be expected as the hydrogen must first diffuse into the oxide layer, then F^- can also diffuse into and cause the niobium dissolved in acid. Because the enthalpy of niobium fluoride is very large, this chemical reaction is exothermic.

In water chemical polishing[1] (WCP: $HF : HNO_3$: $H_2O = 1:1:5$) from $10-40^{\circ}C$ the removal rate increases and the hydrogen contamination decreases. Above $40^{\circ}C$ the removal rate and hydrogen contamination increase acceleratively.

At low temperature $(10^{\circ}C)$, the oxide layer is more stable because of OH^{-} , so the etching rate and doping rate of hydrogen are lower, then the hydrogen contamination is higher. When temperature increases, the concentration of OH^{-} will decrease and hydrogen activity increase, then etching rate increases and hydrogen contamination decreases. When temperature is larger than $40^{\circ}C$ the diffusion current will increase so rapidly that the internal stress can not be accumulated sufficiently especially on the dislocations or grain boundaries. Thus at high temperature, the grain boundary etching and dislocation pitting may happen.

In buffered chemical polishing (BCP; $HF : HNO_3 : H_3PO_4 = 1 : 1 : 4)[1]$ the oxide layer will still exist on the niobium surface because of the concentrated nitride acid. The doping rate is lower because of high viscosity of the H_3PO_4 , then the hydrogen contamination may be larger. There is no OH^- in BCP, so (OH) does not exist in the oxide layer, thus there is no decrease of hydrogen contamination with in some temperature range.

It is very interesting to note that the prevention of hydrogen contamination mainly depends on hydrogen themselves. In some condition the hydrogen contamination may become severe if the hydrogen doping rate is very small.

5 Segregation and precipitation

After the chemical polishing at room temperature a 2-6 nm oxide layer and 10-30 μ depth of hydrogen contamination may be exist on the niobium surface.

The hydrogen distribution (4.2) can be rewrittenas

$$C_H^T(\boldsymbol{x}) = \boldsymbol{a}^T - \sqrt{\boldsymbol{b}^T \boldsymbol{x}}$$
(5.1)

In the above-mentioned example: T=300K, $x_{max} = 20\mu$,

 $a^T = 500 wppm$, $b^T = 12500(wppm)^2 \cdot \mu^{-1}$ and total hydrogen content AH=3333.3 wppm· μ .

The solubility limit decreases rapidly with the temperature (Table 1), so under the operation of the cavity at 4.2K the depth of $\epsilon - Nb_4H_3$ can reach 0.4μ if all hydrogen were precipitated on the surface. The R_s of $\epsilon - Nb_4H_3$ is ~ $15m\Omega[7]$ and the effective skin depth is ~ 0.6μ , thus the Q value of the cavity can be reduced sharply. The field penetration at superconducting state is ~ 40nm, so only the NbH precipitated on the surface can affect the performance of the cavity.

If we keep the cavity at lower temperature, e.g. 250K. then hydrogen will be re-distributed. At 250K, $C_H^{max} \sim 200 wppm$ (table 1). From (5.1) we get

$$C_{H}^{300K}(x=7.2\mu)=a^{250K}=200wppm$$

When $x < 7.2\mu$, $C_H > C_H^{max}$, then $D_H^* < 0$ and segregation can happen i.e. the hydrogen content above 200 wppm (720 wppm μ) will be precipitated on the surface, thus a saturation area $(x < 7.2\mu)$ can be formed.

When $x > 7.2\mu$ and near 7.2μ , $C_H \sim C_H^{max}$, then $D_H^* \sim 0$ i.e. $j_H \sim 0$, thus under the internal stress the hydrogen concentration near 7.2μ will be reduced

If the total hydrogen content $(x > 7.2\mu)$ maintain constant, then steady state of hydrogen distribution at 250K can be represented as

$$C_{H}^{250K}(\boldsymbol{x}) = \begin{cases} 200 & \boldsymbol{x} < 7.2\\ 200 - \sqrt{2272.7(\boldsymbol{x} - 7.2)} & 7.2 < \boldsymbol{x} < 24.8 \end{cases}$$
(5.2)

This hydrogen distribution (5.2) have two large gradients at x=0 and $x=7.2\mu$, respectively. These gradients can approach infinity if steady state is reached. It may take very long time to reach steady state because the chemical diffusion coefficient is very small.

When the cavity is finally cooldown to 4.2K, the segregation at x=0 and $x=7.2\mu$ can happen and these location can become the nucleation sites of the precipitations. In this case only 1440 wppm· μ hydrogen are precipitated on the surface and other 1893.3 wppm· μ are precipitated at the layer $x = 7.2\mu$.

From this example, if we keep the cavity at higher temperature then cooldown, the precipitation on the surface will be further reduced.

Rinsing at temperature $20^{\circ}C$ for several hours may reduce the precipitation on the surface, thus this can explain why the Q value is large at the first cooldown.

From the experiment[4], the precipitation were submicron size particles with dense prismatic loop dislocations. When the specimen was warmed again, these particles were redissolved but some dislocation skeletons remained. Cooling again below the solvus, these dislocation skeletons often provided nucleation sites for the precipitating hydrogen. This is also a reason to explain that the Q value degrades after successive cooldown.

In this paper the analysis of the hydrogen behaviors is mainly concentrated on the steady states. In order to find the optimum condition for the cavity it is necessary to do transient analysis. To establish the transient model depends on further investigations and experiments.

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References

- G.Enderlein et al., "Investigation on hydrogen contamination of superconducting cavities" IEEE Particle Accelerator Conference, San Francisco, May 6-9 (1991)
- [2] G.Hörz, H.Speck, E.Fromm, H.Jehn, "Gases and Carbon in Metals Pt.VIII: Group VA Metalls(2) Niobium" Max-Plank-Institute, Stuttgard, Germany 1981
- [3] K.K.Schulze, "Preparation and Characterization of Ultra-High-Purity Niobium", Journal of Metals, PP.33-41 May (1981)
- [4] T.Schober and H.Wenzel, "The Systems NbH(D), TaH(D), VH(D): Structures, Phase Diagrams, Morphologies, Methods of Preparation", in Hydrogen in Metalls II Ed. by G.Alefeld, J.Völkl, Springer, Berlin 1978 pp.11-71
- [5] M.Grundner and J.Halbritter, "XPS and AES studies on oxide and oxide coating on niobium", J. Appl. Phys. 51, 397 (1980)
- [6] D.G.Westlake, "Hydrogen Embrittlement: A resistometric Study of Niobium-Hydrogen Alloys", Transaction of the Metallurgical Society of AIME, 245,287 (1969)
- [7] D.Moffat, P.Barnes, J.Graber,
 J.Kirchgessner, H.Padamsee, J.Potts, D.Rubin, Q.Shu,
 "Increase in RF Surface Resistance of Niobium as a Result of Acid Treatment", CLNS 90/1035 (1990)